

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

# 11 / Supp.  
IDS  
12-5-01  
R. H. H.

In re application of  
Shinji T. KEDA et al.

Serial No. 09/785,486

Filed: February 20, 2001

For: SEMICONDUCTOR DEVICE AND  
PROCESS FOR FABRICATION  
THEREOF

)  
) Atty. Docket No.: TM&K0008  
)  
) Group Art Unit: 2814  
)  
) Examiner:  
)  
)  
)  
) Date: November 30, 2001  
)

**SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Assistant Commissioner for Patents  
Washington, D.C. 20231

Sir:

This is an Information Disclosure Statement with regard to the above-identified application. Copies of each of the documents listed in the attached Form PTO/SB/08A are attached.

Document A relates to an electrically resistive, highly densified diamond-packed thermal conduit. Document B relates to a semiconductor device and its manufacturing method. Document C relates to electrically conductive bonding films. Document D relates to an epoxy resin composition. Document E relates to a thermally stable adhesive. Document F relates to an optical shutter array and a method for making it. Document G relates to a housing for electromagnetic interference shielding. Document H relates to compliant and crosslinkable thermal interface materials. Document I relates to polyimide and doped metal oxide fuser components. Document J relates to cast lubricating films and their composites.

Documents A, B, and C were cited in the Office Action dated September 25, 2001 in applicants' corresponding U.S. Application Serial No. 09/785,436. Documents D, E, F, G, H, I,

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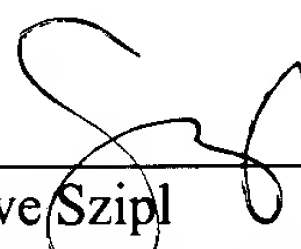
and J were cited in the Office Action dated October 29, 2001 in applicants' corresponding U.S. Application Serial No. 09/616,943. No items of information contained in this information disclosure statement were cited in a communication from a foreign patent office in a counterpart foreign application, and, to the knowledge of the undersigned attorney for applicants after making reasonable inquiry, no item of information contained in this information disclosure statement was known to any individual designated in § 1.56(c) more than three months prior to the filing of this information disclosure statement.

It is respectfully requested that the attached documents be considered and officially cited, and that a copy of the Form PTO/SB/08A, initialed by the Examiner to indicate that the documents have been considered, be returned to the applicants.

Since no Office Action has issued in this case, it is believed that no fee is required. However, if it is determined that a fee is required, authorization is hereby given to deduct said fee from the undersigned's Deposit Account No. 50-1281.

Respectfully submitted,

GRIFFIN & SZIPL, P.C.

  
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